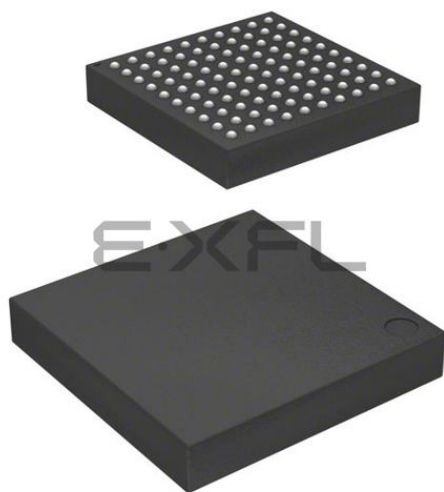




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"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "[Embedded - Microcontrollers](#)"

Details

Product Status	Not For New Designs
Core Processor	RX
Core Size	32-Bit Single-Core
Speed	100MHz
Connectivity	CANbus, EBI/EMI, I ² C, LINbus, SCI, SPI, USB
Peripherals	DMA, LVD, POR, PWM, WDT
Number of I/O	78
Program Memory Size	2MB (2M x 8)
Program Memory Type	FLASH
EEPROM Size	32K x 8
RAM Size	128K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 3.6V
Data Converters	A/D 8x10b, 14x12b; D/A 1x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	100-TFLGA
Supplier Device Package	100-TFLGA (7x7)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f5631ecdjlj-u0

Table 1.3 List of Products (2/8)

Group	Part No.	Package	ROM Capacity	RAM Capacity	E2 Data Flash	Operating Frequency (Max.)	Operating Temp. Range
RX63N (D version)	R5F563NDDDLK	PTLG0145KA-A	1.5 Mbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NBCDLK	PTLG0145KA-A	1 Mbyte	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NBDDLK	PTLG0145KA-A	1 Mbyte	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NACDLK	PTLG0145KA-A	768 Kbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NADDLK	PTLG0145KA-A	768 Kbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NFHDFB	PLQP0144KA-A	2 Mbytes	256 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NFDDFB	PLQP0144KA-A	2 Mbytes	256 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NKHDFB	PLQP0144KA-A*1	2 Mbytes	192 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NKDDFB	PLQP0144KA-A	2 Mbytes	192 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NECDFB	PLQP0144KA-A	2 Mbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NEDDFB	PLQP0144KA-A	2 Mbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NJHDFB	PLQP0144KA-A*1	1.5 Mbytes	256 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NJDDFB	PLQP0144KA-A*1	1.5 Mbytes	256 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NGHDFB	PLQP0144KA-A*1	1.5 Mbytes	192 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NGDDFB	PLQP0144KA-A*1	1.5 Mbytes	192 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NDCDFB	PLQP0144KA-A	1.5 Mbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NDDDFB	PLQP0144KA-A	1.5 Mbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NYHDFB	PLQP0144KA-A	1 Mbyte	256 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NYDDFB	PLQP0144KA-A	1 Mbyte	256 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NWHDFB	PLQP0144KA-A	1 Mbyte	192 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NWDDFB	PLQP0144KA-A	1 Mbyte	192 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NBCDFB	PLQP0144KA-A	1 Mbyte	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NBDDFB	PLQP0144KA-A	1 Mbyte	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NACDFB	PLQP0144KA-A	768 Kbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NADDFB	PLQP0144KA-A	768 Kbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NECDLJ	PTLG0100JA-A	2 Mbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NEDDLJ	PTLG0100JA-A	2 Mbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NDCDLJ	PTLG0100JA-A*1	1.5 Mbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NDDDLJ	PTLG0100JA-A*1	1.5 Mbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NBCDLJ	PTLG0100JA-A	1 Mbyte	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NBDDLJ	PTLG0100JA-A	1 Mbyte	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NACDLJ	PTLG0100JA-A	768 Kbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NADDLJ	PTLG0100JA-A	768 Kbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NFHDFP	PLQP0100KB-A	2 Mbytes	256 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NFDDFP	PLQP0100KB-A	2 Mbytes	256 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NKHDFP	PLQP0100KB-A*1	2 Mbytes	192 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NKDDFP	PLQP0100KB-A	2 Mbytes	192 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NECDFP	PLQP0100KB-A	2 Mbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NEDDFP	PLQP0100KB-A	2 Mbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NJHDFP	PLQP0100KB-A*1	1.5 Mbytes	256 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NJDDFP	PLQP0100KB-A*1	1.5 Mbytes	256 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NGHDFP	PLQP0100KB-A*1	1.5 Mbytes	192 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NGDDFP	PLQP0100KB-A*1	1.5 Mbytes	192 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NDCDFP	PLQP0100KB-A	1.5 Mbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NDDDFP	PLQP0100KB-A	1.5 Mbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C

Table 1.3 List of Products (3/8)

Group	Part No.	Package	ROM Capacity	RAM Capacity	E2 Data Flash	Operating Frequency (Max.)	Operating Temp. Range
RX63N (D version)	R5F563NYHDFP	PLQP0100KB-A	1 Mbyte	256 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NYDDFP	PLQP0100KB-A	1 Mbyte	256 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NWHDFP	PLQP0100KB-A	1 Mbyte	192 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NWDDFP	PLQP0100KB-A	1 Mbyte	192 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NWGDFP	PLQP0100KB-A*1	1 Mbyte	192 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NWCDFP	PLQP0100KB-A*1	1 Mbyte	192 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NBCDFP	PLQP0100KB-A	1 Mbyte	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NBDDFP	PLQP0100KB-A	1 Mbyte	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NACDFP	PLQP0100KB-A	768 Kbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F563NADDFP	PLQP0100KB-A	768 Kbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
RX63N (G version) *2	R5F563NFHGFC	PLQP0176KB-A	2 Mbytes	256 Kbytes	32 Kbytes	100 MHz	-40 to +105°C
	R5F563NFDGFC	PLQP0176KB-A	2 Mbytes	256 Kbytes	32 Kbytes	100 MHz	-40 to +105°C
	R5F563NKDGFC	PLQP0176KB-A	2 Mbytes	192 Kbytes	32 Kbytes	100 MHz	-40 to +105°C
	R5F563NEDGFC	PLQP0176KB-A	2 Mbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +105°C
	R5F563NDDGFC	PLQP0176KB-A	1.5 Mbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +105°C
	R5F563NYHGFC	PLQP0176KB-A	1 Mbyte	256 Kbytes	32 Kbytes	100 MHz	-40 to +105°C
	R5F563NYDGFC	PLQP0176KB-A	1 Mbyte	256 Kbytes	32 Kbytes	100 MHz	-40 to +105°C
	R5F563NWHGFC	PLQP0176KB-A	1 Mbyte	192 Kbytes	32 Kbytes	100 MHz	-40 to +105°C
	R5F563NWDGFC	PLQP0176KB-A	1 Mbyte	192 Kbytes	32 Kbytes	100 MHz	-40 to +105°C
	R5F563NBDGFC	PLQP0176KB-A	1 Mbyte	128 Kbytes	32 Kbytes	100 MHz	-40 to +105°C
	R5F563NADGFC	PLQP0176KB-A	768 Kbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +105°C
	R5F563NFHGF	PLQP0144KA-A	2 Mbytes	256 Kbytes	32 Kbytes	100 MHz	-40 to +105°C
	R5F563NFDGF	PLQP0144KA-A	2 Mbytes	256 Kbytes	32 Kbytes	100 MHz	-40 to +105°C
	R5F563NKDGF	PLQP0144KA-A	2 Mbytes	192 Kbytes	32 Kbytes	100 MHz	-40 to +105°C
	R5F563NEDGF	PLQP0144KA-A	2 Mbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +105°C
	R5F563NDDGF	PLQP0144KA-A	1.5 Mbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +105°C
	R5F563NYHGF	PLQP0144KA-A	1 Mbyte	256 Kbytes	32 Kbytes	100 MHz	-40 to +105°C
	R5F563NYDGF	PLQP0144KA-A	1 Mbyte	256 Kbytes	32 Kbytes	100 MHz	-40 to +105°C
	R5F563NWHGF	PLQP0144KA-A	1 Mbyte	192 Kbytes	32 Kbytes	100 MHz	-40 to +105°C
	R5F563NWDGF	PLQP0144KA-A	1 Mbyte	192 Kbytes	32 Kbytes	100 MHz	-40 to +105°C
	R5F563NBDGF	PLQP0144KA-A	1 Mbyte	128 Kbytes	32 Kbytes	100 MHz	-40 to +105°C
	R5F563NADGF	PLQP0144KA-A	768 Kbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +105°C
	R5F563NFHGF	PLQP0100KB-A	2 Mbytes	256 Kbytes	32 Kbytes	100 MHz	-40 to +105°C
	R5F563NFDGF	PLQP0100KB-A	2 Mbytes	256 Kbytes	32 Kbytes	100 MHz	-40 to +105°C
	R5F563NKDGF	PLQP0100KB-A	2 Mbytes	192 Kbytes	32 Kbytes	100 MHz	-40 to +105°C
	R5F563NEDGF	PLQP0100KB-A	2 Mbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +105°C
	R5F563NDDGF	PLQP0100KB-A	1.5 Mbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +105°C
	R5F563NYHGF	PLQP0100KB-A	1 Mbyte	256 Kbytes	32 Kbytes	100 MHz	-40 to +105°C
	R5F563NYDGF	PLQP0100KB-A	1 Mbyte	256 Kbytes	32 Kbytes	100 MHz	-40 to +105°C
	R5F563NWHGF	PLQP0100KB-A	1 Mbyte	192 Kbytes	32 Kbytes	100 MHz	-40 to +105°C
	R5F563NWDGF	PLQP0100KB-A	1 Mbyte	192 Kbytes	32 Kbytes	100 MHz	-40 to +105°C
	R5F563NBDGF	PLQP0100KB-A	1 Mbyte	128 Kbytes	32 Kbytes	100 MHz	-40 to +105°C
	R5F563NADGF	PLQP0100KB-A	768 Kbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +105°C
RX631 (D version)	R5F5631ECDLC	PTLG0177KA-A	2 Mbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C
	R5F5631EDDLC	PTLG0177KA-A	2 Mbytes	128 Kbytes	32 Kbytes	100 MHz	-40 to +85°C

Table 1.4 Pin Functions (2/6)

Classifications	Pin Name	I/O	Description
Bus control	RD#	Output	Strobe signal which indicates that reading from the external bus interface space is in progress.
	WR#	Output	Strobe signal which indicates that writing to the external bus interface space is in progress, in 1-write strobe mode.
	WR0# to WR3#	Output	Strobe signals which indicate that either group of data bus pins (D7 to D0, D15 to D8, D23 to D16, and D31 to D24) is valid in writing to the external bus interface space, in byte strobe mode.
	BC0# to BC3#	Output	Strobe signals which indicate that either group of data bus pins (D7 to D0, D15 to D8, D23 to D16, and D31 to D24) is valid in access to the external bus interface space, in 1-write strobe mode.
	ALE	Output	Address latch signal when address/data multiplexed bus is selected.
	CKE	Output	Output pin for SDRAM clock enable signals.
	SDCS#	Output	Output pin for SDRAM chip select signals.
	RAS#	Output	Output pin for SDRAM row address strobe signals.
	CAS#	Output	Output pin for SDRAM column address strobe signals.
	WE#	Output	Output pin for SDRAM write enable signals.
	DQM0 to DQM3	Output	Output pins for SDRAM I/O data mask enable signals.
	CS0# to CS7#	Output	Select signals for CS area.
	WAIT#	Input	Input pins for wait request signals in access to the external space.
EXDMA controller	EDREQ0, EDREQ1		Input pins for external DMA transfer requests.
	EDACK0, EDACK1		Output pins for single address transfer acknowledge signals.
Interrupt	NMI	Input	Non-maskable interrupt request signal.
	IRQ0 to IRQ15	Input	Maskable interrupt request signals.
Multi-function timer pulse unit 2	MTIOC0A, MTIOC0B MTIOC0C, MTIOC0D	I/O	The TGRA0 to TGRD0 input capture input/output compare output/PWM output pins.
	MTIOC1A, MTIOC1B	I/O	The TGRA1 and TGRB1 input capture input/output compare output/PWM output pins.
	MTIOC2A, MTIOC2B	I/O	The TGRA2 and TGRB2 input capture input/output compare output/PWM output pins.
	MTIOC3A, MTIOC3B MTIOC3C, MTIOC3D	I/O	The TGRA3 to TGRD3 input capture input/output compare output/PWM output pins.
	MTIOC4A, MTIOC4B MTIOC4C, MTIOC4D	I/O	The TGRA4 to TGRD4 input capture input/output compare output/PWM output pins.
	MTIC5U, MTIC5V MTIC5W	Input	The TGRU5, TGRV5, and TGRW5 input capture input/dead time compensation input pins.
	MTCLKA, MTCLKB MTCLKC, MTCLKD	Input	Input pins for external clock signals.
Port output enable 2	POE0# to POE3# POE8#	Input	Input pins for request signals to place the MTU large-current pins in the high impedance state.

Table 1.4 Pin Functions (5/6)

Classifications	Pin Name	I/O	Description
Ethernet controller	ET_MDIO	I/O	Inputs or outputs bidirectional signals for exchange of management information between the RX63N Group and the PHY-LSI.
Parallel data capture unit (PDC)	PIXCLK	Input	Parallel data transfer clock
	VSYNC	Input	Vertical synchronization signal
	HSYNC	Input	Horizontal synchronization signal
	PIXD7 to PIXD0	Input	8-bit data
	PCKO	Output	Outputs parallel data transfer clock signal
USB power pins	VCC_USB	Input	Power supply pin. When the USB is not to be used, connect it to the VCC pin.
	VSS_USB	Input	Ground pin. When the USB is not to be used, connect it to the VSS pin.
USB 2.0 host/function module	USB0_DP, USB1_DP	I/O	Inputs or outputs USB transceiver D+ data.
	USB0_DM, USB1_DM	I/O	Inputs or outputs USB transceiver D- data.
	USB0_VBUS, USB1_VBUS	Input	Input pins for detection of connection and disconnection of the USB cable.
	USB0_EXICEN	Output	Output pin for control the low power of the OTG chip.
	USB0_VBUSEN	Output	Supply enable pin of VBUS (5 V) for the OTG chip.
	USB0_OVRCURA, USB0_OVRCURB,	Input	Input pin for detection of external over current.
	USB0_ID	Input	ID input pin of mini-AB connector at the OTG operation.
	USB0_DPUPE, USB1_DPUPE	Output	Pull-up control pins of the D+ signal at the function operation.
	USB0_DPRPD	Output	Pull-down control pins of the D+ signal at the host operation.
	USB0_DRPD	Output	Pull-down control pins of the D- signal at the host operation.
CAN module	CRX0 to CRX2	Input	Input pin.
	CTX0 to CTX2	Output	Output pin.
Serial peripheral interface	RSPCKA, RSPCKB, RSPCKC	I/O	Clock input/output pin.
	MOSIA, MOSIB, MOSIC	I/O	Inputs or outputs data output from the master.
	MISOA, MISOB, MISOC	I/O	Inputs or outputs data output from the slave.
	SSLA0, SSLB0, SSLC0	I/O	Input or output pins slave selection
	SSLA1 to SSLA3, SSLB1 to SSLB3, SSLC1 to SSLC3	Output	Output pins slave selection
IEBus controller	IERXD	Input	Input pin for data reception.
	IETXD	Output	Output pin for data transmission.
Realtime clock	RTCOUT	Output	Output pin for 1-Hz clock.
	RTCIC0 to RTCIC2	Input	Time capture event input pin
12-bit A/D converter	AN000 to AN020	Input	Input pins for the analog signals to be processed by the A/D converter.
	ADTRG0#	Input	Input pins for the external trigger signals that start the A/D conversion.
10-bit A/D converter	AN0 to AN7	Input	Input pins for the analog signals to be processed by the A/D converter.
	ANEX0	Output	Extended analog output pin
	ANEX1	Input	Extended analog input pin
	ADTRG#	Input	Input pins for the external trigger signals that start the A/D conversion.
D/A converter	DA0, DA1	Output	Output pins for the analog signals to be processed by the D/A converter.

Note 3. Enabled only for the ROM capacity: 2 Mbytes/1.5 Mbytes

Table 1.6 List of Pin and Pin Functions (176-Pin LQFP) (1/5)

Pin Number 176-Pin LQFP	Power Supply Clock System Control	I/O Port	Bus EXDMAC SDRAMC	Timer (MTU, TPU, TMR, PPG, RTC, POE)	Communications (ETHERC, SCIC, SCID, RSPI, RIIC, CAN, IEB, USB, and PDC)	Interrupt	S12AD, AD, DA
1	AVSS0						
2		P05				IRQ13	DA1
3	VREFH						
4		P03				IRQ11	DA0
5	VREFL						
6		P02		TMCI1	SCK6	IRQ10	AN020
7		P01		TMCI0	RXD6/SMISO6/SSCL6	IRQ9	AN019
8		P00		TMRI0	TXD6/SMOSI6/SSDA6	IRQ8	AN018
9		PF5				IRQ4	
10	EMLE						
11		PJ5					
12	VSS						
13		PJ3		MTIOC3C	CTS6#/RTS6#/CTS0#/ RTS0#/SS6#/SS0#		
14	VCL						
15	VBATT						
16	NC						
17	TRST#	PF4					
18	MD/FINED						
19	XCIN						
20	XCOUT						
21	RES#						
22	XTAL	P37					
23	VSS						
24	EXTAL	P36					
25	VCC						
26		P35				NMI	
27		P34		MTIOC0A/TMCI3/PO12/ POE2#	SCK6/SCK0/ USB0_DPRPD	IRQ4	
28		P33		MTIOC0D/TIOC0D/ TMRI3/PO11/POE3#	RXD6/RXD0/SMISO6/ SMISO0/SSCL6/SSCL0/ CRX0/PCKO	IRQ3-DS	
29		P32		MTIOC0C/TIOCC0/TMO3/ PO10/RTCOU/RTCIC2	TXD6/TXD0/SMOSI6/ SMOSI0/SSDA6/SSDA0/ CTX0/USB0_VBUSEN/ VSYNC	IRQ2-DS	
30	TMS	PF3					
31	TDI	PF2			RXD1/SMISO1/SSCL1		
32		P31		MTIOC4D/TMCI2/PO9/ RTCIC1	CTS1#/RTS1#/SS1#/ SSLB0/USB0_DPUPE	IRQ1-DS	
33		P30		MTIOC4B/TMRI3/PO8/ RTCIC0/POE8#	RXD1/SMISO1/SSCL1/ MISOB/USB0_DRPD	IRQ0-DS	
34	TCK/FINEC	PF1			SCK1		
35	TDO	PF0			TXD1/SMOSI1/SSDA1		
36		P27	CS7#	MTIOC2B/TMCI3/PO7	SCK1/RSPCKB		
37		P26	CS6#	MTIOC2A/TMO1/PO6	TXD1/CTS3#/RTS3#/ SMOSI1/SS3#/SSDA1/ MOSIB		
38		P25	CS5#/EDACK1	MTIOC4C/MTCLKB/ TIOCA4/PO5	RXD3/SMISO3/SSCL3/ USB0_DPRPD/HSYNC		ADTRG0#
39	VCC						
40		P24	CS4#/EDREQ1	MTIOC4A/MTCLKA/ TIOCB4/TMRI1/PO4	SCK3/USB0_VBUSEN/ PIXCLK		

Table 1.8 List of Pins and Pin Functions (144-Pin LQFP) (3/5)

Pin No.	Power Supply Clock System Control	I/O Port	Bus EXDMAC SDRAMC	Timers (MTU, TPU, TMR, PPG, RTC, POE)	Communications (ETHERC, SCIC, SCID, RSPI, RIIC, CAN, IEB, USB, and PDC)	Interrupt	S12AD AD DA
64	TRDATA1	P81	EDACK0	MTIOC3D/PO27	RXD10/SMISO10/ SSCL10/ET_ETXD0/ RMII_TXD0		
65	TRDATA0	P80	EDREQ0	MTIOC3B/PO26	SCK10/ET_TX_EN/ RMII_TXD_EN		
66		PC4	A20/CS3#	MTIOC3D/MTCLKC/ TIOCC6/TCLKE/ TMC11/PO25/POE0#	SCK5/CTS8#/RTS8#/ SS8#/SSLA0/ ET_TX_CLK		
67		PC3	A19	MTIOC4D/TCLKB/ PO24	TXD5/SMOSI5/SSDA5/ IETXD/ET_TX_ER		
68		P77	CS7#	PO23	TXD11/SMOSI11/ SSDA11/ET_RX_ER/ RMII_RX_ER		
69		P76	CS6#	PO22	RXD11/SMISO11/ SSCL11/ET_RX_CLK/ REF50CK		
70		PC2	A18	MTIOC4B/TCLKA/ PO21	RXD5/SMISO5/SSCL5/ SSLA3/IERXD/ ET_RX_DV		
71		P75	CS5#	PO20	SCK11/ET_ERXD0/ RMII_RXD0		
72		P74	CS4#	PO19	CTS11#/RTS11#/ SS11#/ET_ERXD1/ RMII_RXD1		
73		PC1	A17	MTIOC3A/TCLKD/ PO18	SCK5/SSLA2/SDA3/ ET_ERXD2	IRQ12	
74	VCC						
75		PC0	A16	MTIOC3C/TCLKC/ PO17	CTS5#/RTS5#/SS5#/ SSLA1/SCL3/ ET_ERXD3	IRQ14	
76	VSS						
77		P73	CS3#	PO16	ET_WOL		
78		PB7	A15	MTIOC3B/TIOCB5/ PO31	TXD9/SMOSI9/SSDA9/ ET_CRS/ RMII_CRS_DV		
79		PB6	A14	MTIOC3D/TIOCA5/ PO30	RXD9/SMISO9/SSCL9/ ET_ETXD1/RMII_TXD1		
80		PB5	A13	MTIOC2A/MTIOC1B/ TIOCB4/TMRI1/PO29/ POE1#	SCK9/ET_ETXD0/ RMII_TXD0		
81		PB4	A12	TIOCA4/PO28	CTS9#/RTS9#/SS9#/ ET_TX_EN/ RMII_TXD_EN		
82		PB3	A11	MTIOC0A/MTIOC4A/ TIOCD3/TCLKD/TMO0/ PO27/POE3#	SCK4/SCK6/ ET_RX_ER/ RMII_RX_ER		
83		PB2	A10	TIOCC3/TCLKC/PO26	CTS4#/RTS4#/CTS6#/ RTS6#/SS4#/SS6#/ ET_RX_CLK/REF50CK		
84		PB1	A9	MTIOC0C/MTIOC4C/ TIOCB3/TMC10/PO25	TXD4/TXD6/SMOSI4/ SMOSI6/SSDA4/ SSDA6/ET_ERXD0/ RMII_RXD0	IRQ4-DS	
85		P72	CS2#		ET_MDC		
86		P71	CS1#		ET_MDIO		
87		PB0	A8	MTIC5W/TIOCA3/ PO24	RXD4/RXD6/SMISO4/ SMISO6/SSCL4/ SSCL6/RSPCKA/ T_ERXD1/RMII_RXD1	IRQ12	
88		PA7	A7	TIOCB2/PO23	MISOA/ET_WOL		

Table 1.9 List of Pins and Pin Functions (100-Pin TFLGA) (3/5)

Pin No. 100-pin TFLGA	Power Supply Clock System Control	I/O Port	Bus EXDMAC	Timers (MTU, TPU, TMR, PPG, RTC, POE)	Communications (ETHERC, SC1c, SC1d, RSPI, RIIC, CAN, IEB, USB)	Interrupt	S12AD AD DA
F7		PB2	A10	TIOCC3/ TCLKC/PO26	CTS6#/RTS6#/ SS6#/ET_RX_CLK/ REF50CK		
F8		PB0	A8	MTIC5W/ TIOCA3/PO24	RXD6/SMISO6/ SSCL6/RSPCKA/ ET_ERXD1/ RMII_RXD1	IRQ12	
F9		PA7	A7	TIOCB2/PO23	MISOA/ET_WOL		
F10	VSS						
G1		P33		MTIOC0D/ TIOC0D/ TMRI3/PO11/ POE3#	RXD6/RXD0/ SMISO6/SMISO0/ SSCL6/SSCL0/ CRX0*1	IRQ3-DS	
G2	TMS	P31		MTIOC4D/ TMC12/PO9/ RTIC1C1	CTS1#/RTS1#/ SS1#/SSLB0/ USB0_DPUPE	IRQ1-DS	
G3	TDI	P30		MTIOC4B/ TMRI3/PO8/ RTIC1C0/POE8#	RXD1/SMISO1/ SSCL1/MISOB/ USB0_DRPD	IRQ0-DS	
G4	TCK/FINEC	P27	CS7#	MTIOC2B/ TMC13/PO7	SCK1/RSPCKB		
G5	BCLK	P53*2					
G6		P52	RD#		RXD2/SMISO2/ SSCL2/SSLB3		
G7		PB5	A13	MTIOC2A/ MTIOC1B/ TIOCB4/ TMRI1/PO29/ POE1#	SCK9/ET_ETXD0/ RMII_TXD0		
G8		PB4	A12	TIOCA4/PO28	CTS9#/RTS9#/ SS9#/ET_TX_EN/ RMII_TXD_EN		
G9		PB1	A9	MTIOC0C/ MTIOC4C/ TIOCB3/ TMC10/PO25	TXD6/SMOSI6/ SSDA6/ET_ERXD0/ RMII_RXD0	IRQ4-DS	
G10	VCC						
H1	TDO	P26	CS6#	MTIOC2A/ TMO1/PO6	TXD1/CTS3#/ RTS3#/SMOSI1/ SS3#/SSDA1/ MOSIB		
H2		P25	CS5#/ EDACK1	MTIOC4C/ MTCLKB/ TIOCA4/PO5	RXD3/SMISO3/ SSCL3/ USB0_DPRPD		ADTRG0#
H3		P16		MTIOC3C/ MTIOC3D/ TIOCB1/ TCLKC/TMO2/ PO14/RTCOUT	TXD1/RXD3/ SMOSI1/SMISO3/ SSDA1/SSCL3/ MOSIA/SCL2-DS/ IERXD/ USB0_VBUS/ USB0_VBUSEN/ USB0_OVRCURB	IRQ6	ADTRG0#

Table 1.12 List of Pins and Pin Functions (64-Pin LQFP) (2/3)

Pin Number 64-Pin LQFP	Power Supply Clock System Control	I/O Port	Timer (MTU2a, TPUa, TMR, PPG, RTCa, POE2a)	Timer Communications (SClC, SClD, RSPI, RIIC, CAN, IEB, USB)	Interrupt	S12ADa, DAa
32		PC2	MTIOC4B/TCLKA/ PO21	RXD5/SMISO5/SSCL5/ SSLA3/IERXD		
33		PB7/ PC1	MTIOC3B/TIOCB5/ PO31	TXD9/SMOSI9/SSDA9		
34		PB6/ PC0	MTIOC3D/TIOCA5/ PO30	RXD9/SMISO9/SSCL9		
35		PB5	MTIOC2A/MTIOC1B/ TIOCB4/TMRI1/PO29/ POE1#	SCK9		
36		PB3	MTIOC0A/MTIOC4A/ TIOCD3/TCLKD/TMO0/ PO27/POE3#	SCK6		
37		PB1	MTIOC0C/MTIOC4C/ TIOCB3/TMCI0/PO25	TXD6/SMOSI6/SSDA6	IRQ4-DS	
38	VCC					
39		PB0	MTIC5W/TIOCA3/PO24	RXD6/SMISO6/SSCL6/ RSPCKA	IRQ12	
40	VSS					
41		PA6	MTIC5V/MTCLKB/ TIOCA2/TMCI3/PO22/ POE2#	CTS5#/RTS5#/SS5#/ MOSIA		
42		PA4	MTIC5U/MTCLKA/ TIOCA1/TMRI0/PO20	TXD5/SMOSI5/SSDA5/ SSLA0	IRQ5-DS	
43		PA3	MTIOC0D/MTCLKD/ TIOCD0/TCLKB/PO19	RXD5/SMISO5/SSCL5	IRQ6-DS	
44		PA1	MTIOC0B/MTCLKC/ TIOCB0/PO17	SCK5/SSLA2/SCL2	IRQ11	
45		PA0	MTIOC4A/TIOCA0/ PO16	SSLA1		
46		PE5	MTIOC4C/MTIOC2B	RSPCKB	IRQ5	AN013
47		PE4	MTIOC4D/MTIOC1A/ PO28	SSLB0		AN012
48		PE3	MTIOC4B/PO26/POE8#	CTS12#/RTS12#/ SS12#/MISOB		AN011
49		PE2	MTIOC4A/PO23	RXD12/SMISO12/ SSCL12/RXDX12/ SSLB3/MOSIB	IRQ7-DS	AN010
50		PE1	MTIOC4C/PO18	TXD12/SMOSI12/SSDA12/ TXDX12/SIOX12/SSLB2/ RSPCKB		AN009
51		PE0		SCK12/SSLB1		AN008
52	VREFL					
53		P46			IRQ14-DS	AN006
54	VREFH					
55		P44			IRQ12-DS	AN004
56		P43			IRQ11-DS	AN003
57		P42			IRQ10-DS	AN002
58		P41			IRQ9-DS	AN001
59	VREFL0					
60		P40			IRQ8-DS	AN000

Table 1.13 List of Pins and Pin Functions (48-Pin LQFP) (2/2)

Pin Number 48-Pin LQFP	Power Supply Clock System Control	I/O Port	Timer (MTU2a, TPUa, TMR, PPG, POE2a)	Communications (SC1c, SC1d, RSPI, RIIC, CAN, IEB, USB)	Interrupt	S12ADa, DAa
29		PB0/ PC0	MTIC5W/TIOCA3/PO24	RXD6/SMISO6/SSCL6/ RSPCKA	IRQ12	
30	VSS					
31		PA6	MTIC5V/MTCLKB/TIOCA2/ TMC13/PO22/POE2#	CTS5#/RTS5#/SS5#/ MOSIA		
32		PA4	MTIC5U/MTCLKA/ TIOCA1/TMRI0/PO20	TXD5/SMOSI5/SSDA5/ SSLA0	IRQ5-DS	
33		PA3	MTIOC0D/MTCLKD/ TIOC0D/TCLKB/PO19	RXD5/SMISO5/SSCL5	IRQ6-DS	
34		PA1	MTIOC0B/MTCLKC/ TIOCB0/PO17	SCK5/SSLA2	IRQ11	
35		PE4	MTIOC4D/MTIOC1A/ PO28	SSLB0		AN012
36		PE3	MTIOC4B/PO26/POE8#	CTS12#/RTS12#/SS12#/ MISOB		AN011
37		PE2	MTIOC4A/PO23	RXD12/SMISO12/SSCL12/ RXDX12/ SSLB3/MOSIB	IRQ7-DS	AN010
38		PE1	MTIOC4C/PO18	TXD12/SMISO12/SSDA12/ TXDX12/SIOX12/SSLB2/ RSPCKB		AN009
39	VREFL					
40		P46			IRQ14-DS	AN006
41	VREFH					
42		P42			IRQ10-DS	AN002
43		P41			IRQ9-DS	AN001
44	VREFL0					
45		P40			IRQ8-DS	AN000
46	VREFH0					
47	AVCC0					
48	AVSS0					

Table 4.1 List of I/O Registers (Address Order) (39/50)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access States		Related Function
						ICLK≥PCLK	ICLK<PCLK	
000A 003Ah	USB0	BEMP interrupt enable register	BEMPENB	16	16	9 PCLKB or more	Rounded up to the nearest integer greater than 1 + 9/ (frequency ratio of ICLK/ PCLKB) ^{*6}	USBa
000A 003Ch	USB0	SOF output configuration register	SOFCFG	16	16	9 PCLKB or more	Rounded up to the nearest integer greater than 1 + 9/ (frequency ratio of ICLK/ PCLKB) ^{*6}	
000A 0040h	USB0	Interrupt status register 0	INTSTS0	16	16	9 PCLKB or more	Rounded up to the nearest integer greater than 1 + 9/ (frequency ratio of ICLK/ PCLKB) ^{*6}	
000A 0042h	USB0	Interrupt status register 1	INTSTS1	16	16	9 PCLKB or more	Rounded up to the nearest integer greater than 1 + 9/ (frequency ratio of ICLK/ PCLKB) ^{*6}	
000A 0046h	USB0	BRDY interrupt status register	BRDYSTS	16	16	9 PCLKB or more	Rounded up to the nearest integer greater than 1 + 9/ (frequency ratio of ICLK/ PCLKB) ^{*6}	
000A 0048h	USB0	NRDY interrupt status register	NRDYSTS	16	16	9 PCLKB or more	Rounded up to the nearest integer greater than 1 + 9/ (frequency ratio of ICLK/ PCLKB) ^{*6}	
000A 004Ah	USB0	BEMP interrupt status register	BEMPSTS	16	16	9 PCLKB or more	Rounded up to the nearest integer greater than 1 + 9/ (frequency ratio of ICLK/ PCLKB) ^{*6}	
000A 004Ch	USB0	Frame number register	FRMNUM	16	16	9 PCLKB or more	Rounded up to the nearest integer greater than 1 + 9/ (frequency ratio of ICLK/ PCLKB) ^{*6}	USBa
000A 004Eh	USB0	Device state changing register	DVCHGR	16	16	9 PCLKB or more	Rounded up to the nearest integer greater than 1 + 9/ (frequency ratio of ICLK/ PCLKB) ^{*6}	
000A 0050h	USB0	USB address register	USBADDR	16	16	9 PCLKB or more	Rounded up to the nearest integer greater than 1 + 9/ (frequency ratio of ICLK/ PCLKB) ^{*6}	

- Note 1. Supply current values are with all output pins unloaded and all input pull-up MOSs in the off state.
- Note 2. Measured with clocks supplied to the peripheral functions. This does not include the BGO operation.
- Note 3. I_{CC} depends on f (ICLK) as follows. (ICLK:PCLK:BCLK:BCLK pin = 8:4:4:2)
 I_{CC} Max. = $0.87 \times f + 13$ (max. operation in high-speed operating mode)
 I_{CC} Typ. = $0.35 \times f + 5$ (normal operation in high-speed operating mode)
 I_{CC} Typ. = $1.0 \times f + 3$ (low-speed operating mode 1)
 I_{CC} Max. = $0.53 \times f + 12$ (sleep mode)
- Note 4. This does not include the BGO operation.
- Note 5. This is the increase for programming or erasure of the ROM or flash memory for data storage during program execution.
- Note 6. Supply of the clock signal to peripherals is stopped in this state. This does not include the BGO operation.
- Note 7. The reference power supply current is included in the power supply current value for 10-bit A/D conversion and D/A conversion.
- Note 8. When V_{BATT} is used
- Note 9. The current values for 10-bit A/D converter and 10-bit D/A converter are included in the current from the VREFH pin.
- Note 10. The values are the sum of I_{AVCC0} and I_{VREFH} .

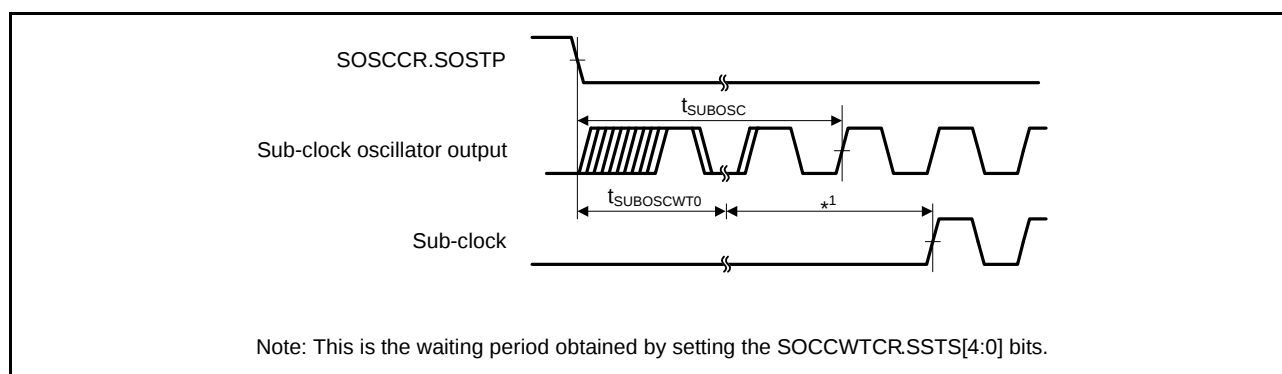


Figure 5.12 Sub-Clock Oscillation Start Timing

5.3.3 Timing of Recovery from Low Power Consumption Modes

Table 5.14 Timing of Recovery from Low Power Consumption Modes

Conditions: $V_{CC} = AV_{CC0} = V_{REFH} = V_{CC_USB} = V_{BATT} = 2.7$ to 3.6 V, $V_{REFH0} = 2.7$ V to AV_{CC0} ,
 $V_{SS} = AV_{SS0} = V_{REFL}/V_{REFL0} = V_{SS_USB} = 0$ V, $T_a = T_{opr}$

Item			Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Recovery time after cancellation of software standby mode	Crystal resonator connected to main clock oscillator	Main clock oscillator operating	t _{SBYMC}	10	—	—	ms	Figure 5.13
		Main clock oscillator and PLL circuit operating	t _{SBYPC}	10	—	—	ms	
	External clock input to main clock oscillator	Main clock oscillator operating	t _{SBYEX}	1	—	—	ms	
		Main clock oscillator and PLL circuit operating	t _{SBYPE}	1	—	—	ms	
	Sub-clock oscillator operating		t _{SBYSC}	2	—	—	s	
	High-speed on-chip oscillator operating		t _{SBYHO}	—	—	2	ms	
	Low-speed on-chip oscillator or IWDG-dedicated on-chip oscillator operating		t _{SBYLO}	—	—	800	μs	
Recovery time after cancellation of deep software standby mode			t _{DSBY}	—	—	1.0	ms	Figure 5.14
Wait time after cancellation of deep software standby mode			t _{DSBYWT}	45	—	46	t _{cyc}	

Note: The wait time varies depending on the state in which each oscillator was when the WAIT instruction was executed. The recovery time when multiple oscillators are operating is the same period as that when the oscillator which requires the longest time of all operating oscillators to recover is operating alone.

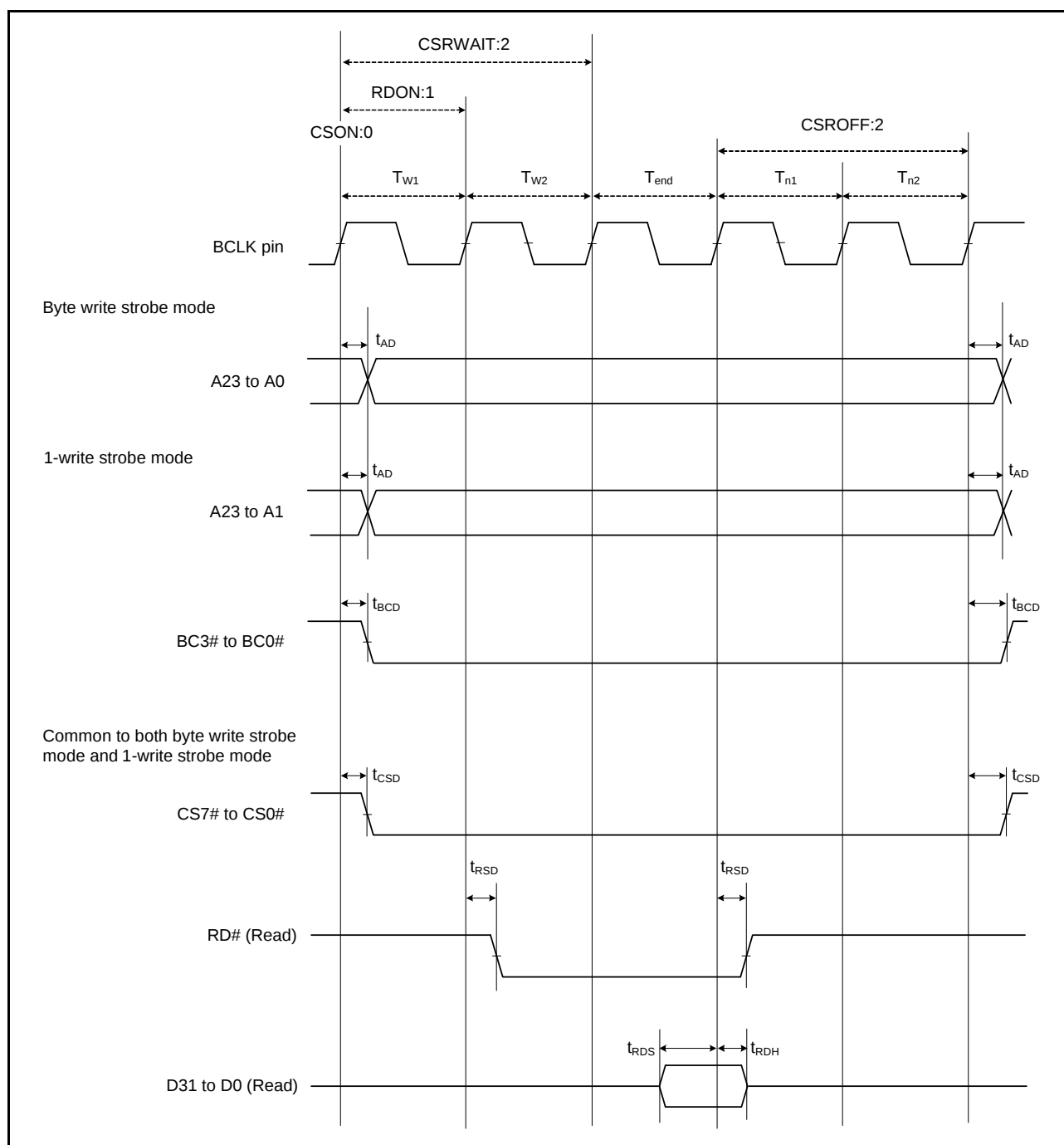


Figure 5.19 External Bus Timing/Normal Read Cycle (Bus Clock Synchronized)

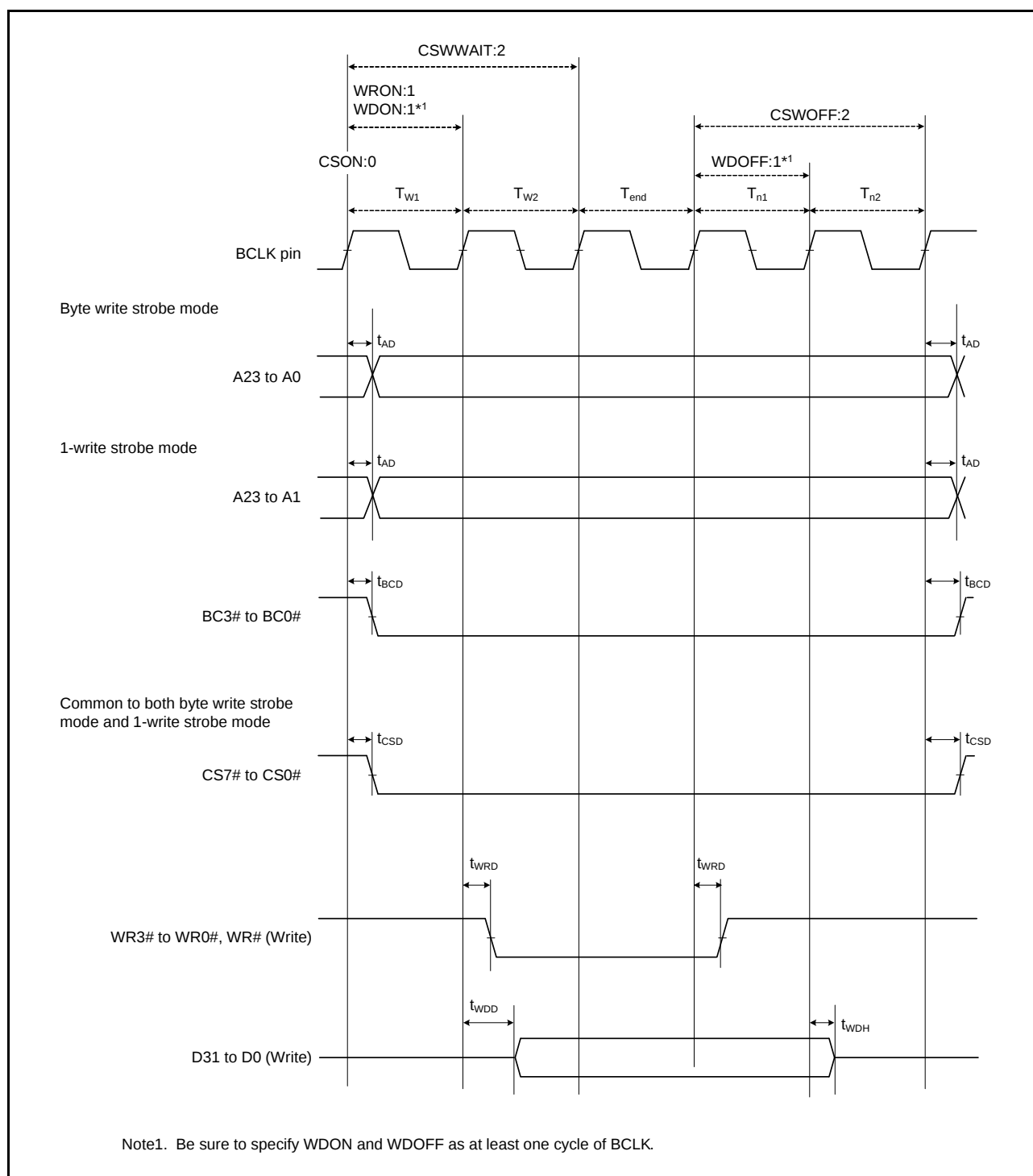


Figure 5.20 External Bus Timing/Normal Write Cycle (Bus Clock Synchronized)

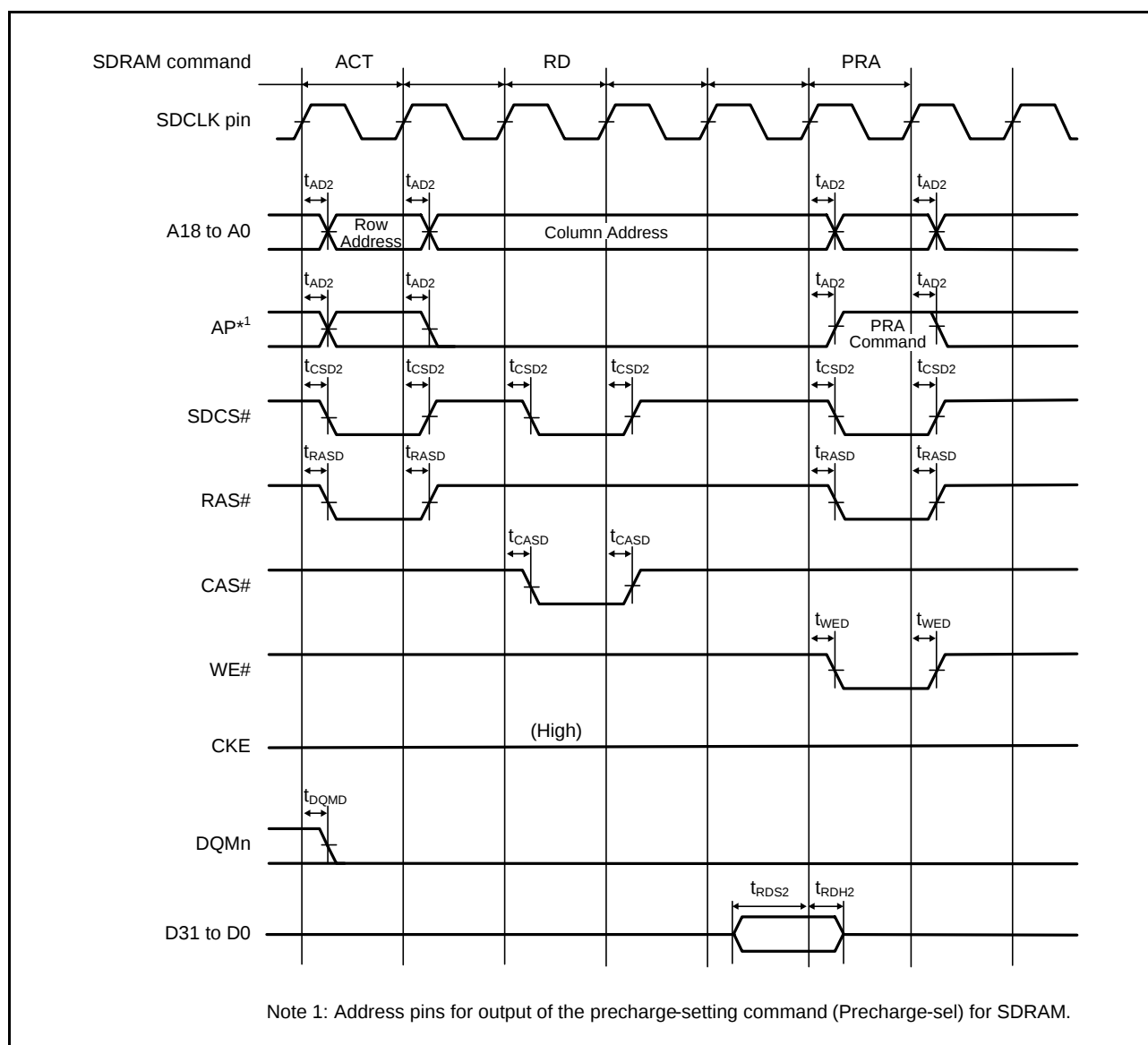


Figure 5.24 SDRAM Space Single Read Bus Timing

Table 5.22 Timing of On-Chip Peripheral Modules (4)Conditions: $V_{CC} = AVCC0 = VREFH = VCC_USB = 2.7$ to 3.6 V, $VREFH0 = 2.7$ V to $AVCC0$ $VSS = AVSS0 = VREFL/VREFL0 = VSS_USB = 0$ V

PCLK = 8 to 50 MHz

 $T_a = T_{opr}$

High drive output is selected by the drive capacity control register.

Item		Symbol	Min.	Max.	Unit*1	Test Conditions
Simple SPI	SCK clock cycle output (master)	t_{SPcyc}	4	65536	t_{Pcyc}	Figure 5.42
	SCK clock cycle input (slave)		8	65536		
	SCK clock high pulse width	t_{SPCKWH}	0.4	0.6	t_{SPcyc}	
	SCK clock low pulse width	t_{SPCKWL}	0.4	0.6	t_{SPcyc}	
	SCK clock rise/fall time	t_{SPCKr}, t_{SPCKf}	—	20	ns	
	Data input setup time	t_{SU}	40	—	ns	Figure 5.43 to Figure 5.46
	Data input hold time	t_H	40	—	ns	
	SS input setup time	t_{LEAD}	1	—	t_{SPcyc}	
	SS input hold time	t_{LAG}	1	—	t_{SPcyc}	
	Data output delay time	t_{OD}	—	40	ns	
	Data output hold time	t_{OH}	−10	—	ns	Figure 5.46
	Data rise/fall time	t_{Dr}, t_{Df}	—	20	ns	
	SS input rise/fall time	t_{SSLr}, t_{SSLf}	—	20	ns	
	Slave access time	t_{SA}	—	5	t_{Pcyc}	
	Slave output release time	t_{REL}	—	5	t_{Pcyc}	

Note 1. t_{Pcyc} : PCLK cycle

Table 5.25 Timing of On-Chip Peripheral Modules (7)

Conditions: VCC = AVCC0 = VREFH = VCC_USB = 2.7 to 3.6 V, VREFH0 = 2.7 V to AVCC0

VSS = AVSS0 = VREFL/VREFL0 = VSS_USB = 0 V

ICLK = 12.5 to 100 MHz, T_a = T_{opr}

High drive output is selected by the drive capacity control register.

Item		Symbol	Min.	Max.	Unit	Test Conditions
ETHERC(RMII)	REF50CK cycle time	T _{ck}	20	—	ns	Figure 5.48 to Figure 5.51
	REF50CK frequency Typ. 50 MHz	—	—	50 + 100ppm	MHz	
	REF50CK duty	—	35	65	%	
	REF50CK rise/fall time	T _{ckr/ckf}	0.5	3.5	ns	
	RMII_XXXX*1 output delay time	T _{co}	2.5	15.0	ns	
	RMII_XXXX*2 setup time	T _{su}	3	—	ns	
	RMII_XXXX*2 hold time	T _{hd}	1	—	ns	
	RMII_XXXX*1, *2 rise/fall time	Tr/Tf	0.5	6	ns	
	ET_WOL output delay time	t _{WOLd}	1	23.5	ns	Figure 5.52
ETHERC(MII)	ET_TX_CLK cycle time	t _{Tcyc}	40	—	ns	—
	ET_TX_EN output delay time	t _{TEND}	1	20	ns	Figure 5.53
	ET_ETXD0 to ET_ETXD3 output delay time	t _{MTDd}	1	20	ns	
	ET_CRs setup time	t _{CRSs}	10	—	ns	
	ET_CRs hold time	t _{CRSh}	10	—	ns	
	ET_COL setup time	t _{COLs}	10	—	ns	Figure 5.54
	ET_COL hold time	t _{COLh}	10	—	ns	
	ET_RX_CLK cycle time	t _{TRcyc}	40	—	ns	—
	ET_RX_DV setup time	t _{RDVs}	10	—	ns	Figure 5.55
	ET_RX_DV hold time	t _{RDVh}	10	—	ns	
	ET_ERXD0 to ET_ERXD3 setup time	t _{MRDs}	10	—	ns	
	ET_ERXD0 to ET_ERXD3 hold time	t _{MRDh}	10	—	ns	
	ET_RX_ER setup time	t _{RERs}	10	—	ns	Figure 5.56
	ET_RX_ER hold time	t _{RESh}	10	—	ns	
	ET_WOL output delay time	t _{WOLd}	1	23.5	ns	Figure 5.57

Note 1. RMII_TXD_EN, RMII_TXD1, RMII_TXD0.

Note 2. RMII_CRs_DV, RMII_RXD1, RMII_RXD0, RMII_RX_ER

Rev.	Date	Description	
		Page	Summary
1.60	Mar 13. 2013	Feature	
		1	Changed
		1. Overview	
		2 to 7	Table 1.1 Outline of Specifications: changed, note added
		8	Table 1.2 Comparison of Functions for Different Packages in the RX63N/RX631 Group, changed
		9 to 15	Table 1.3 List of Products, changed
		16	Figure 1.1 How to Read the Product Part No., changed
		17	Figure 1.2 Block Diagram, changed
		24 to 32	Figure 1.3 to Figure 1.11 Pin Assignment: note, added
		53 to 57	Table 1.9 List of Pins and Pin Functions (100-Pin TFLGA), added
		62 to 64	Table 1.11 List of Pins and Pin Functions (64-Pin LQFP), added
		65, 66	Table 1.12 List of Pins and Pin Functions (48-Pin LQFP), added
		3. Address Space	
		71	Figure 3.1 Memory Map in Each Operating Mode, changed
		4. I/O Registers	
		75 to 120	Table 4.1 List of I/O Registers (Address Order), changed
		5. Electrical Characteristics	
		All	Characteristics and timing conditions in the tables, changed
		124, 125	Table 5.4 DC Characteristics (3), changed
		126	Table 5.5 DC Characteristics (4), changed
		127	5.3 AC Characteristics, changed
		130, 131	Table 5.11, Clock Timing (Except for Sub-Clock Related): Condition and the table, changed, note, added
		132	Table 5.12 Clock Timing (Sub-Clock Related): Condition and the table, changed, note, added
		176	Table 5.33 Battery Backup Function Characteristics: Condition, changed
		Appendix 1. Package Dimensions	
		189	Figure H 64-pin LQFP (PLQP0064KB-A), added
		190	Figure I 48-pin LQFP (PLQP0048KB-A), added
1.70	Oct 08. 2013	Features	
		1	changed
		1. Overview	
		2 to 7	Table 1.1 Outline of Specifications, General I/O ports, Packages, changed, Parallel data capture unit (PDC), added.
		8	Table 1.2 Comparison of Functions for Different Packages in the RX63N/RX631 Group, 64-pin LQFP, changed, 64-pin TFLGA, Parallel data capture unit (PDC), added.
		9 to 16	Table 1.3 List of Products, changed.
		17	Figure 1.1 How to Read the Product Part No., changed
		18	Figure 1.2 Block Diagram, changed
		19 to 24	Table 1.4 Pin Functions, changed, Parallel data capture unit (PDC), added
		32	Figure 1.10 Pin Assignment (64-Pin TFLGA), added
		35 to 40	Table 1.5 List of Pin and Pin Functions (177-Pin TFLGA, 176-Pin LFBGA), changed
		41 to 45	Table 1.6 List of Pin and Pin Functions (176-Pin LQFP), changed
		46 to 50	Table 1.7 List of Pins and Pin Functions (145-Pin TFLGA), changed
		51 to 55	Table 1.8 List of Pins and Pin Functions (144-Pin LQFP), changed
		65 to 66	Table 1.11 List of Pins and Pin Functions (64-Pin TFLGA), added
		3. Address Space	
		76	Figure 3.1 Memory Map in Each Operating Mode, changed
		4. I/O Registers	
		79	(4) Restrictions in Relation to RMPA and String-Manipulation Instructions, added

General Precautions in the Handling of MPU/MCU Products

The following usage notes are applicable to all MPU/MCU products from Renesas. For detailed usage notes on the products covered by this document, refer to the relevant sections of the document as well as any technical updates that have been issued for the products.

1. Handling of Unused Pins

Handle unused pins in accordance with the directions given under Handling of Unused Pins in the manual.

- The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible. Unused pins should be handled as described under Handling of Unused Pins in the manual.

2. Processing at Power-on

The state of the product is undefined at the moment when power is supplied.

- The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the moment when power is supplied.
In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the moment when power is supplied until the reset process is completed. In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the moment when power is supplied until the power reaches the level at which resetting has been specified.

3. Prohibition of Access to Reserved Addresses

Access to reserved addresses is prohibited.

- The reserved addresses are provided for the possible future expansion of functions. Do not access these addresses; the correct operation of LSI is not guaranteed if they are accessed.

4. Clock Signals

After applying a reset, only release the reset line after the operating clock signal has become stable. When switching the clock signal during program execution, wait until the target clock signal has stabilized.

- When the clock signal is generated with an external resonator (or from an external oscillator) during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Moreover, when switching to a clock signal produced with an external resonator (or by an external oscillator) while program execution is in progress, wait until the target clock signal is stable.

5. Differences between Products

Before changing from one product to another, i.e. to a product with a different part number, confirm that the change will not lead to problems.

- The characteristics of an MPU or MCU in the same group but having a different part number may differ in terms of the internal memory capacity, layout pattern, and other factors, which can affect the ranges of electrical characteristics, such as characteristic values, operating margins, immunity to noise, and amount of radiated noise. When changing to a product with a different part number, implement a system-evaluation test for the given product.